

LESD7D5.0T5G ESD PROTECTION DIODE

Discription

The LESD7D5.0T5G is designed to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space is at a premium.

Applications

- I Cellular phones audio
- I MP3 players
- I Digital cameras
- I Portable applicationss
- I mobile telephone

Features

- Small Body Outline Dimensions: 0.039" x 0.024"(1.0 mm x 0.60 mm)
- Low Body Height: 0.017" (0.43 mm) Max
- Stand-off Voltage: 3.3 V 12 V
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- IEC61000-4-2 Level 4 ESD Protection
- We declare that the material of product compliance with RoHS requirements.

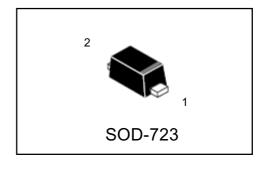
MAXIMUM RATINGS

Rating	Symbol	Value	Unit
IEC61000-4-2 (ESD)	air discharge contact discharge	土 15 土 8	κv
ESD Voltage Per Human Body Model		16	kV
Total Power Dissipation on FR-5 Board (Note 1)	PD	150	Mw
@ T _A =25℃			
Junction and Storage Temperature Range	TJ,TSTG	-55 to 150	°C
Lead Solder Temperature – Maximum (10	TL	260	°C
Second Duration)			

Stresses exceeding Maximum Ratings may damage the device. Maximum Rating are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 = 1.0*0.75*0.62 in.

LESD7D5.0T5G





PIN 1. CATHODE 2. ANODE

Ordering information

Device	Package	Shipping
LESD7D5.0T5G	SOD-723	8000/Tape&Reel



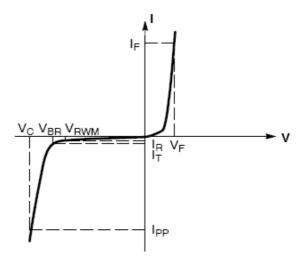


LESD7D5.0T5G

ELECTRICAL CHARACTERISTICS

(T_A = 25°C unless otherwise noted)

Symbol	Parameter
I _{PP}	Maximum Reverse Peak Pulse Current
Vc	Clamping Voltage @ I _{PP}
V _{RWM}	Working Peak Reverse Voltage
I _R	Maximum Reverse Leakage Current @ V _{RWM}
V _{BR}	Breakdown Voltage @ I _T
Ι _Τ	Test Current
١ _F	Forward Current
VF	Forward Voltage @ I _F
P _{pk}	Peak Power Dissipation
С	Max. Capacitance $@V_R = 0$ and f = 1 MHz



Uni-Directional TVS

ELECTRICAL CHARACTERISTICS ((T _A =25 $^{\circ}$ C unless otherwise noted	, VF=0.9V Max. @ IF=10Ma for all types)
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	V _{RWM}	I _R	V_{BR}	Ι _Τ	I _{PP}	Vc	P _{PK}	С
	(V)	(μA)	(V)	(mA)	(A)	(V)	(W)	(pF)
Device		@	@ I _T			@ Max I _{PP}	(8*20 µs)	
		V _{RWM}	(Note 2)		(Note 3)	(Note 3)		
	Max	Max	Min		Max	Max	Тур	Тур
LESD7D3.3T5G	3.3	2.5	5.0	1.0	9.8	10.4	102	80
LESD7D5.0T5G	5.0	1.0	6.2	1.0	8.7	12.3	107	65

Other voltage available upon request.

2. V_{BR} is measured with a pulse test current IT at an ambient temperature of $25\,^\circ\!\!\mathbb{C}$

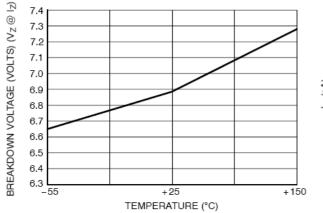
3. Surge current waveform per Figure 3.



LESD7D5.0T5G

TYPICAL CHARACTERISTICS

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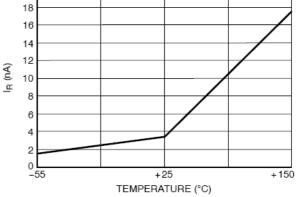
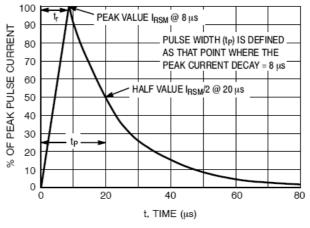


Figure 1. Typical Breakdown Voltage versus Temperature

Fig 2. Typical Leakage Current versus Temperature





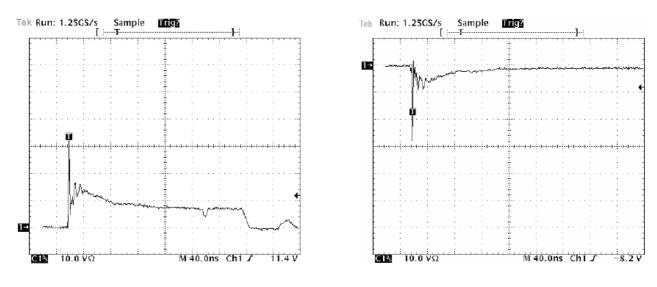




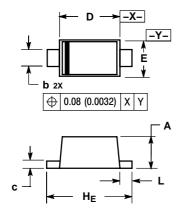


Fig 5. Negative 8kV contact per IEC



LESD7D5.0T5G

SOD-723

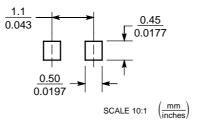


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. MAXIMUM LEAD THICKNESS INCILUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

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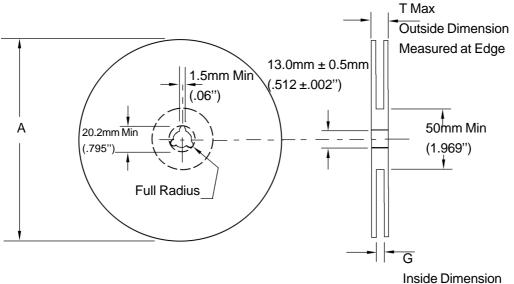
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.49	0.52	0.55	0.019	0.020	0.022
b	0.25	0.28	0.32	0.0098	0.011	0.013
С	0.08	0.12	0.15	0.0032	0.0047	0.0059
D	0.95	1.00	1.05	0.037	0.039	0.041
Е	0.55	0.60	0.65	0.022	0.024	0.026
HE	1.35	1.40	1.45	0.053	0.055	0.057
L	0.15	0.20	0.25	0.006	0.0079	0.010

SOLDERING FOOTPRINT*





EMBOSSED TAPE AND REEL DATA FOR DISCRETES



Measured Near Hub

Size	A Max	G	T Max
8 mm	330mm	8.4mm+1.5mm, -0.0	14.4mm
	(12.992")	(.33"+.059", -0.00)	(.56")

Reel Dimensions

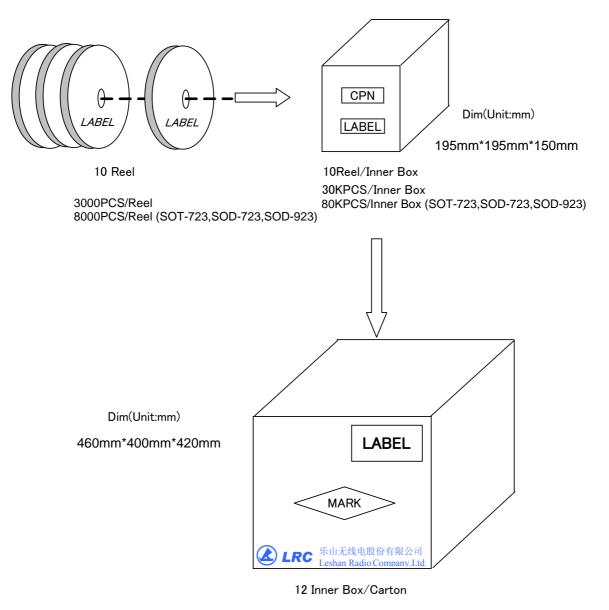
Metric Dimensions Govern - English are in parentheses for reference only

Storage Conditions

Temperature: 5 to 40 Deg.C (20 to 30 Deg. C is preferred) Humidity: 30 to 80 RH (40 to 60 is preferred) Recommended Period: One year after manufacturing (This recommended period is for the soldering condition only. The characteristics and reliabilities of the products are not restricted to this limitation)



Shipment Specification



360KPCS/Carton 960KPCS/Carton (SOT-723,SOD-723,SOD-923)